HALOGEN

FREE



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# P-Channel 80 V (D-S) MOSFET

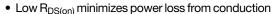


PRODUCT SUMMARY					
V <sub>DS</sub> (V)	-80				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = -10 V	0.0058				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.0081				
Q <sub>g</sub> typ. (nC)	145				
I <sub>D</sub> (A)	-150				
Configuration	Single				

#### **FEATURES**

- TrenchFET® power MOSFET
- · Package with low thermal resistance

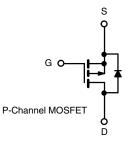




- · Compatible with logic-level gate driving
- 100 % R<sub>q</sub> and UIS tested
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

## **APPLICATIONS**

- Battery protection
- Motor drive control
- · Load switch



ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SUP60061EL-GE3

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)					
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage	$V_{DS}$	-80	V		
Gate-source voltage	$V_{GS}$	± 20	V		
Continuous drain current <sup>d</sup>	T <sub>C</sub> = 25 °C	I <sub>D</sub>	-150 <sup>d</sup>		
(T <sub>J</sub> = 175 °C)	T <sub>C</sub> = 70 °C		-150 <sup>d</sup>		
Pulsed drain current (100 μs)	I <sub>DM</sub>	-250	Α		
Avalanche current	L = 0.1 mH	I <sub>AS</sub>	-75	]	
Single pulse avalanche energy <sup>a</sup>	L = 0.1 IIII	E <sub>AS</sub>	281	mJ	
Power dissipation	T <sub>C</sub> = 25 °C °	D	375	W	
	T <sub>C</sub> = 125 °C b	P <sub>D</sub>	125		
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C	

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount <sup>b</sup>	$R_{thJA}$	40	°C/W
Junction-to-case		$R_{thJC}$	0.4	C/VV

#### **Notes**

- a. Duty cycle ≤ 1 %
- b. When mounted on 1" square PCB (FR4 material)
- c. See SOA curve for voltage derating
- d. Limited by package



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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -10 \text{ mA}$	-80	-	-		
Gate threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = -250 \mu A$	-1.5	-	-2.5	V	
Gate-body leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
		V <sub>DS</sub> = -80 V, V <sub>GS</sub> = 0 V	-	-	-10		
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -64 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	-50	μА	
		V <sub>DS</sub> = -64 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C	-	-	-250		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	-30	-	-	Α	
Drain accuracy on atota vaciations 3	В	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -20 A	-	0.0048	0.0058	Ω	
Drain-source on-state resistance a	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -15 \text{ A}$	-	0.0065	0.0081		
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = -15 V, I <sub>D</sub> = -15 A	-	80	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>		-	9600	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = -40 \text{ V}, f = 1 \text{ MHz}$	-	3300	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	110	=		
Total gate charge <sup>c</sup>	Qg		-	145	218		
Gate-source charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = -40 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -110 \text{ A}$	-	34	-	nC	
Gate-drain charge <sup>c</sup>	Q <sub>gd</sub>		-	16	-		
Gate resistance	Rg	f = 1 MHz	0.46	2.3	4.6	Ω	
Turn-on delay time <sup>c</sup>	t <sub>d(on)</sub>		-	25	35		
Rise time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = -40 \text{ V}, R_1 = 0.71 \Omega$	-	20	30		
Turn-off delay time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong -20 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	90	140	ns	
Fall time <sup>c</sup>	t <sub>f</sub>		-	20	30		
<b>Drain-Source Body Diode Characte</b>	ristics (T <sub>C</sub> = 25	5 °C b)					
Continuous current	Is		-	-	-150	۸	
Pulsed current	I <sub>SM</sub>		-	-	-250	Α	
Forward voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = -10 A, V <sub>GS</sub> = 0 V	-	-0.8	-1.5	V	
Reverse recovery time	t <sub>rr</sub>		-	90	135	ns	
Peak reverse recovery charge	I <sub>RM(REC)</sub>	I <sub>F</sub> = -20 A, dl/dt = 100 A/μs	-	-2.8	-4.2	Α	
Reverse recovery charge	Q <sub>rr</sub>		-	145	218	nC	

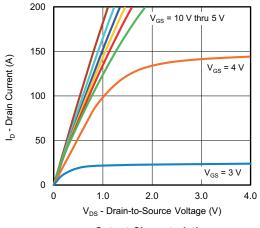
## Notes

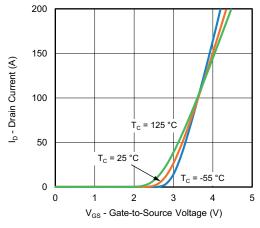
- a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing
- c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



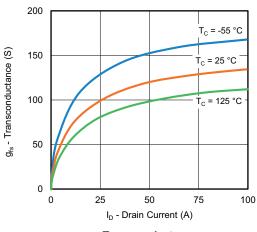
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)

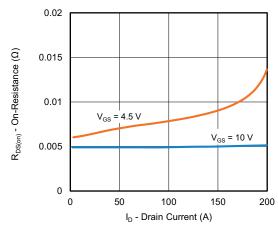




### **Output Characteristics**

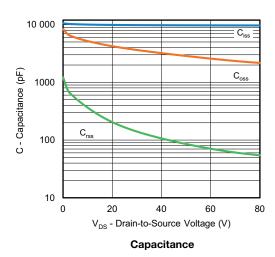


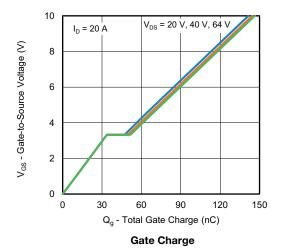




Transconductance

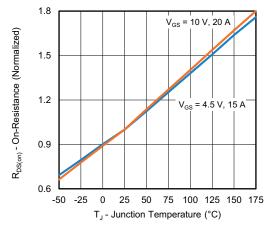
On-Resistance vs. Drain Current



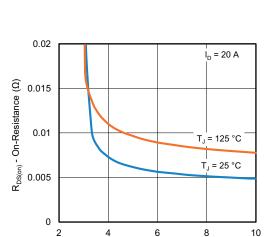




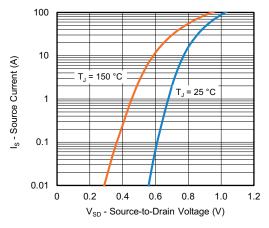
## **TYPICAL CHARACTERISTICS** (T<sub>A</sub> = 25 °C, unless otherwise noted)



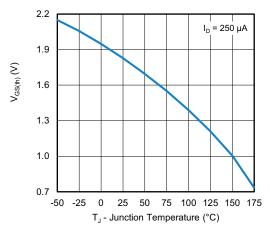
On-Resistance vs. Junction Temperature



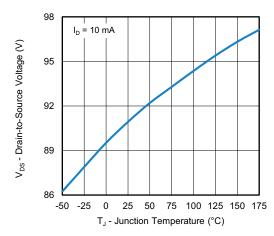
 $\label{eq:VGS} V_{GS} \text{ - Gate-to-Source Voltage (V)}$  On-Resistance vs. Gate-to-Source Voltage



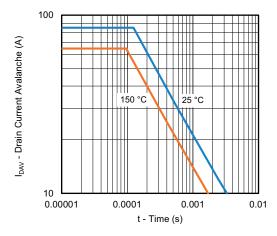
**Source Drain Diode Forward Voltage** 



**Threshold Voltage** 



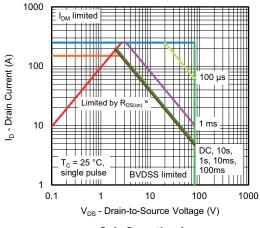
**Drain Source Breakdown vs. Junction Temperature** 



**Avalanche Current vs. Time** 



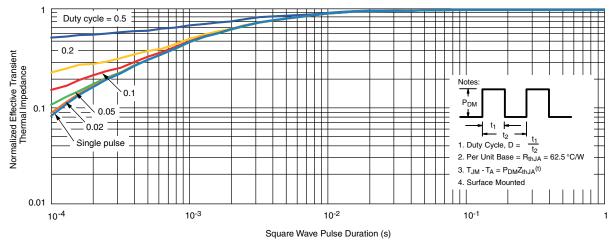
## THERMAL RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted)



### Safe Operating Area

#### Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



Normalized Thermal Transient Impedance, Junction-to-Case

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## **TO-220AB**



	D2

	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
D2	12.19	12.70	0.480	0.500
Е	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØΡ	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471				

#### Note

 $<sup>^{\</sup>star}$  M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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